Kingbright

2.0x1.25mm BI-COLOR SMD CHIP LED LAMP

Part Number: APB2012SURKSYKC

Hyper Red
Super Bright Yellow

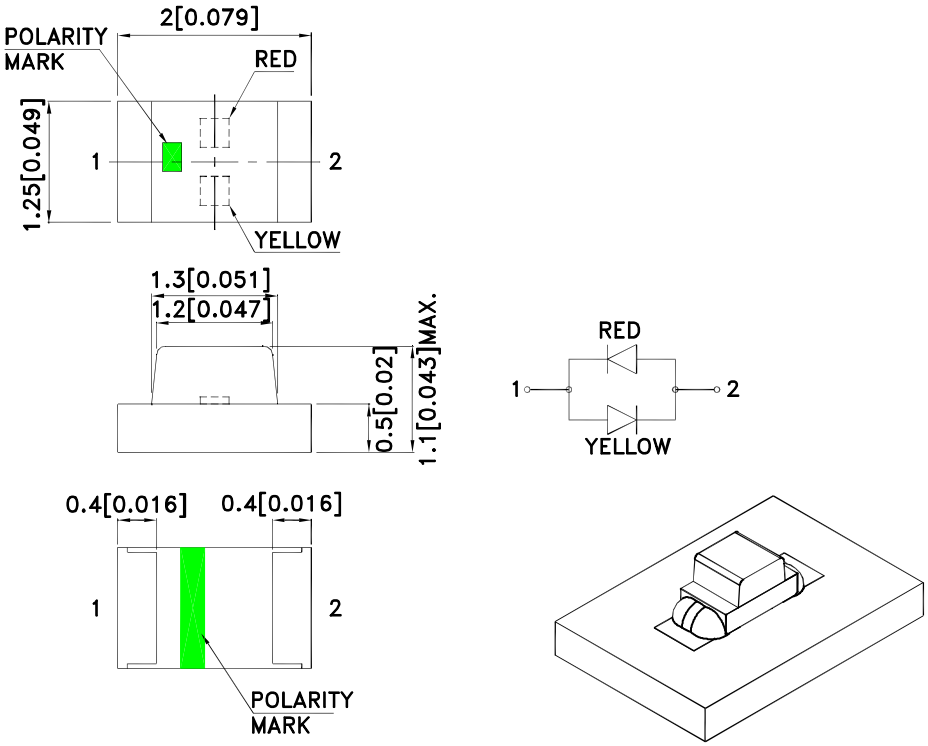
Features

- 2.0mmx1.25mm SMT LED, 1.1mm thickness.
- Bi -color,Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.
The Super Bright Yellow device is made with AlGaInP (on GaAs substrate) light emitting diode chip.

Package Dimensions



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.15(0.006") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Typ.	2θ1/2
APB2012SURKSYKC	Hyper Red (AlGaInP)	Water Clear	120	200	150°
			*40	*80	
	Super Bright Yellow (AlGaInP)		80	120	
			*80	*120	

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.
* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

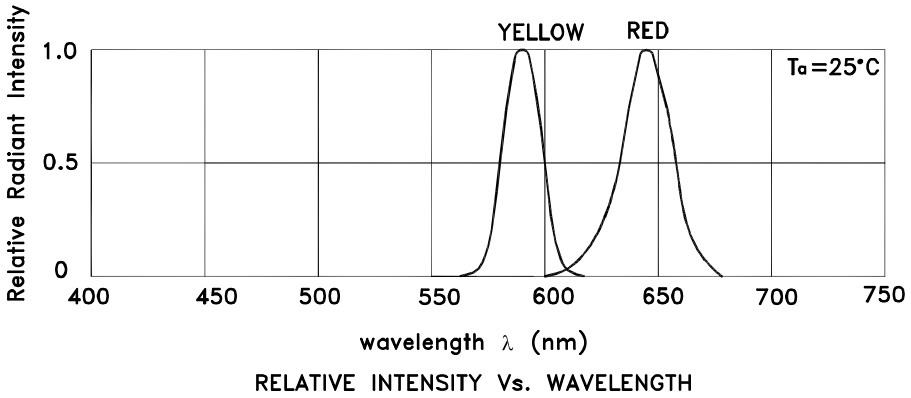
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Super Bright Yellow	645 590		nm	I_F=20mA
λD [1]	Dominant Wavelength	Hyper Red Super Bright Yellow	630 590		nm	I_F=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Super Bright Yellow	28 20		nm	I_F=20mA
C	Capacitance	Hyper Red Super Bright Yellow	35 20		pF	V_F=0V;f=1MHz
V_F [2]	Forward Voltage	Hyper Red Super Bright Yellow	1.95 2	2.5 2.5	V	I_F=20mA

Notes:
1.Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.
3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

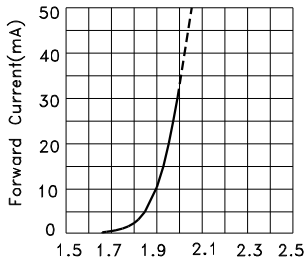
Parameter	Hyper Red	Super Bright Yellow	Units
Power dissipation	75	75	mW
DC Forward Current	30	30	mA
Peak Forward Current [1]	185	175	mA
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

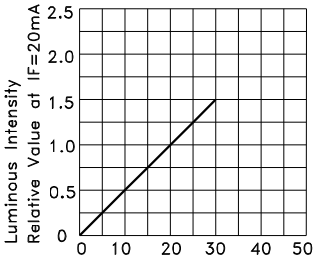


RELATIVE INTENSITY Vs. WAVELENGTH

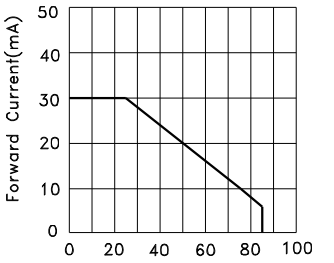
APB2012SURKSYKC
Hyper Red



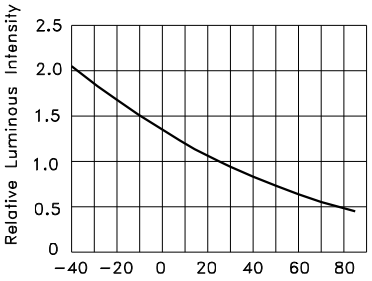
FORWARD CURRENT Vs.
FORWARD VOLTAGE



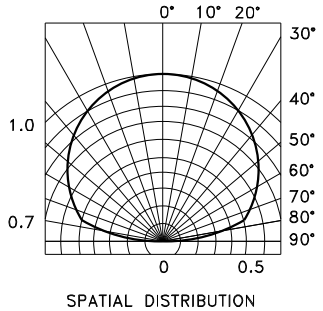
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

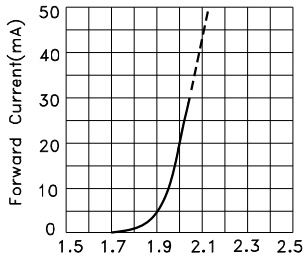


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

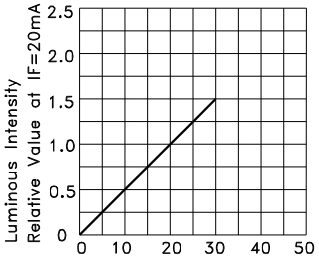


SPATIAL DISTRIBUTION

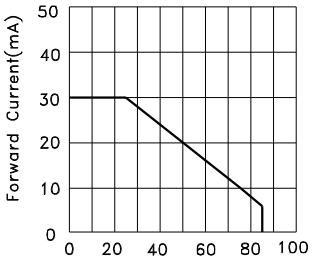
Super Bright Yellow



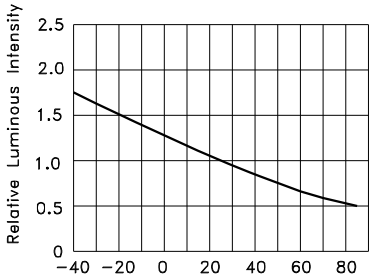
FORWARD CURRENT Vs.
FORWARD VOLTAGE



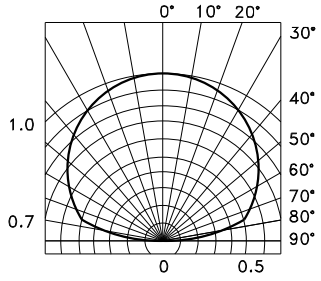
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE



LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

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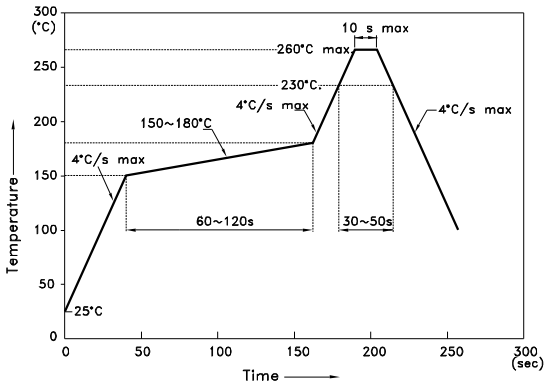
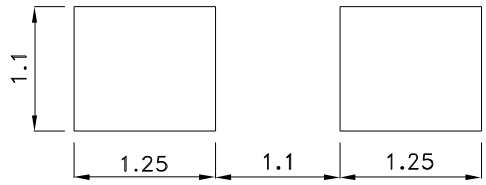
Reflow soldering is recommended and the soldering profile is shown below.
Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

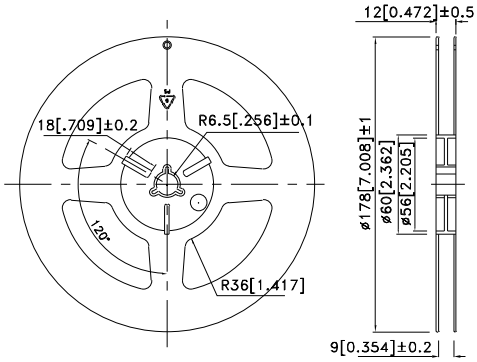


NOTES:
1. We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

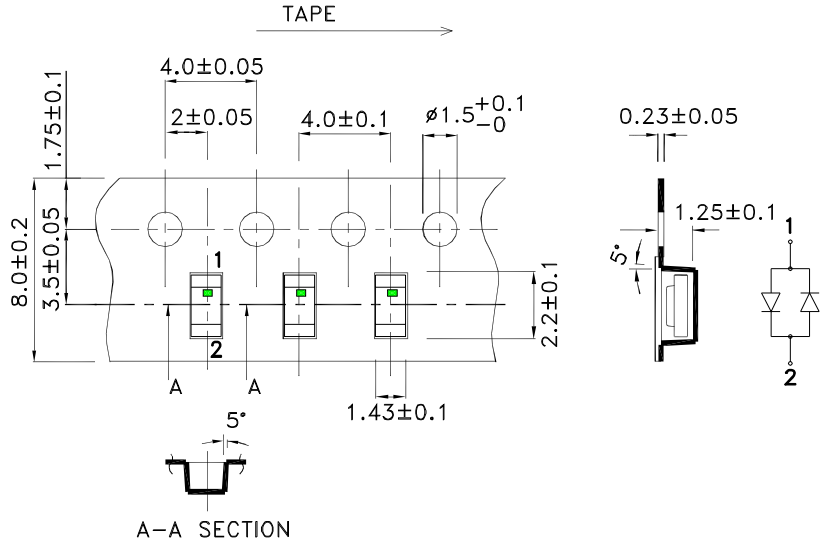
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



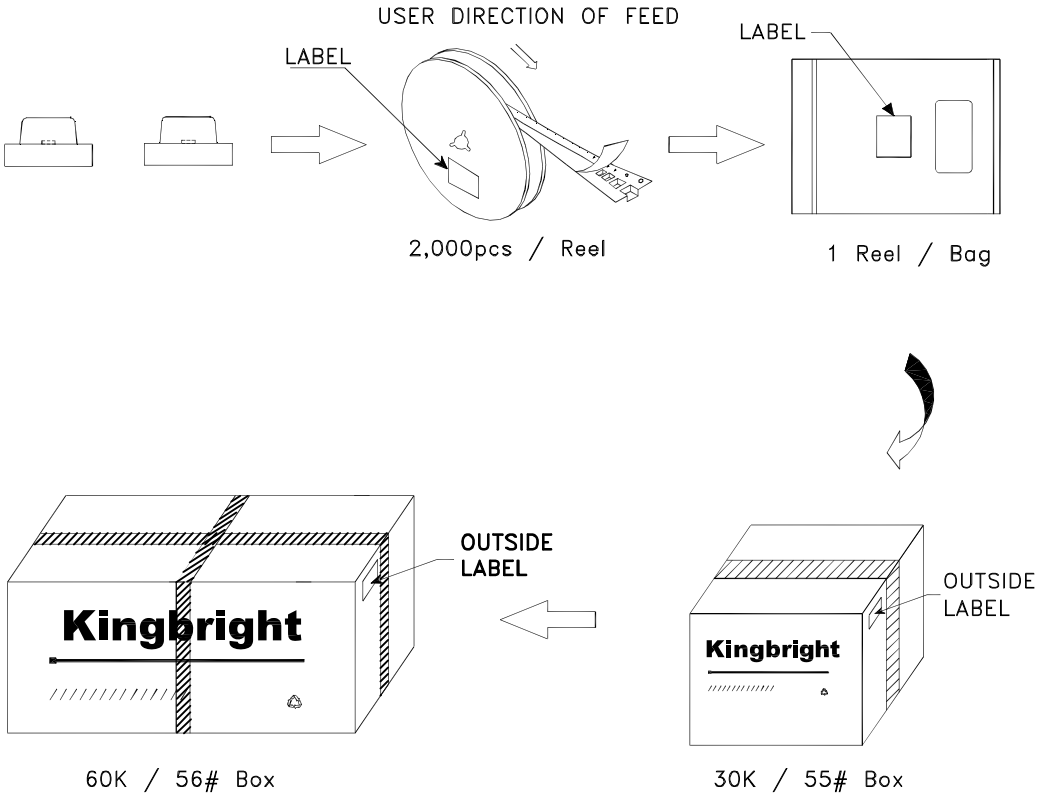
Reel Dimension

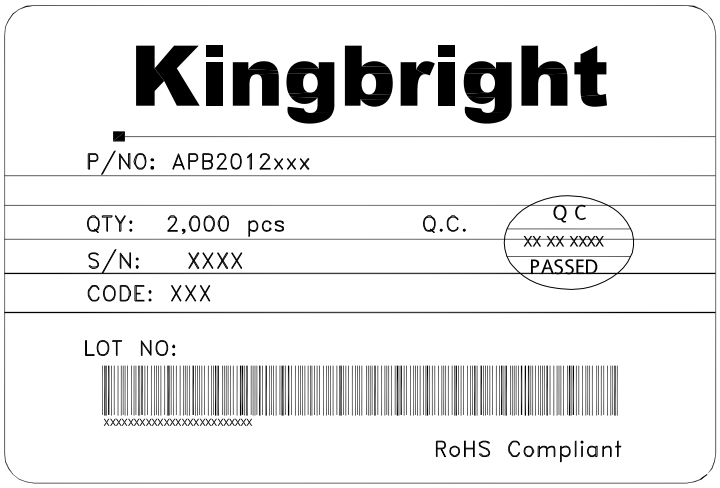


Tape Dimensions (Units : mm)



PACKING & LABEL SPECIFICATIONS **APB2012SURKSYKC**





All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes